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NC7WP240

TinyLogic® ULP Dual Inverting Buffer with 3-STATE Outputs

General Description

The NC7WP240 is a Dual Inverting Buffer with independent active LOW enables for the 3-STATE outputs. The Ultra High Power device is ideal for applications where battery life is critical. This product is designed for ultra low power consumption within the V_{CC} operating range of 0.9V to 3.6V V_{CC} .

The internal circuit is composed of a minimum of inverter stages, including the output buffer, to enable ultra low static and dynamic power.

The NC7WP240 for lower drive requirements, is uniquely designed for optimized power and speed, and is fabricated with an advanced CMOS technology to achieve best in class speed operation while maintaining extremely low CMOS power dissipation.

Features

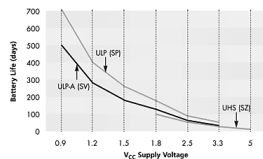
- Space saving US8 surface mount package
- MicroPak™ Pb-Free leadless package
- 0.9V to 3.6V V_{CC} supply operation
- 3.6V overvoltage tolerant I/O's at V_{CC} from 0.9V to 3.6V
- t_{PD}
 - 3.0 ns typ for 3.6V V_{CC}
 - 4.0 ns typ for 2.3V to 2.7V V_{CC}
 - 5.0 ns typ for 1.65V to 1.95V V_{CC}
 - 6.0 ns typ for 1.40V to 1.60V V_{CC}
 - 10.0 ns typ for 1.10V to 1.30V V_{CC}
 - 26.0 ns typ for 0.90V V_{CC}
- Power-Off high impedance inputs and outputs
- Static Drive (I_{OH}/I_{OL})
 - ±2.6 mA @ 3.00V V_{CC}
 - ±2.1 mA @ 2.30V V_{CC}
 - ±1.5 mA @ 1.65V V_{CC}
 - ±1.0 mA @ 1.40V V_{CC}
 - ±0.5 mA @ 1.10V V_{CC}
 - ±20 μ A @ 0.9V V_{CC}
- Uses patented Quiet Series™ noise/EMI reduction circuitry
- Ultra low dynamic power

Ordering Code:

Order Number	Package Number	Product Code Top Mark	Package Description	Supplied As
NC7WP240K8X	MAB08A	WP40	8-Lead US8, JEDEC MO-187, Variation CA 3.1mm Wide	3k Units on Tape and Reel
NC7WP240L8X	MAC08A	Z3	Pb-Free 8-Lead MicroPak, 1.6 mm Wide	5k Units on Tape and Reel

Pb-Free package per JEDEC J-STD-020B.

Battery Life vs. V_{CC} Supply Voltage



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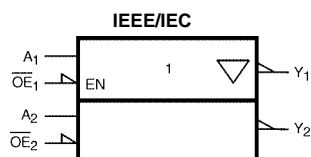
TinyLogic ULP and ULP-A with up to 50% less power consumption can extend your battery life significantly.

$$\text{Battery Life} = (V_{\text{battery}} \cdot I_{\text{battery}} \cdot 9) / (P_{\text{device}}) / 24 \text{hrs/day}$$

$$\text{Where, } P_{\text{device}} = (I_{CC} \cdot V_{CC}) + (C_{PD} + C_L) \cdot V_{CC}^2 \cdot f$$

Assumes ideal 3.6V Lithium Ion battery with current rating of 900mAh and derated 90% and device frequency at 10MHz, with $C_L = 15$ pF load

Logic Symbol



Pin Descriptions

Pin Names	Description
\overline{OE}_n	Enable Inputs for 3-STATE Outputs
A_n	Inputs
Y_n	3-STATE Outputs

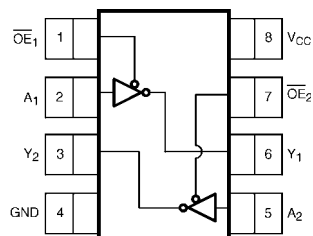
Function Table

Inputs		Output
\overline{OE}	A_n	Y_n
L	L	H
L	H	L
H	L	Z
H	H	Z

H = HIGH Logic Level
L = LOW Logic Level
Z = 3-STATE

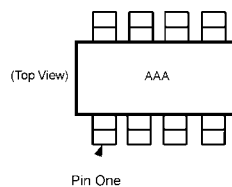
Connection Diagrams

Pin Assignments for US8



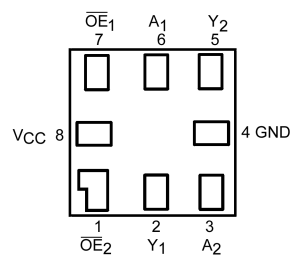
(Top View)

Pin One Orientation Diagram



AAA represents Product Code Top Mark - see ordering code
Note: Orientation of Top Mark determines Pin One location. Read the top product code mark left to right, Pin One is the lower left pin (see diagram).

Pad Assignment for MicroPak



(Top Thru View)

DC Electrical Characteristics (Continued)

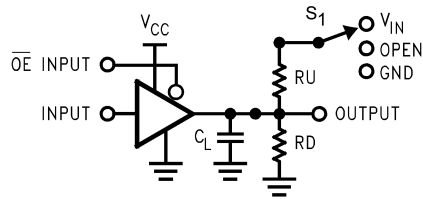
Symbol	Parameter	V _{CC} (V)	T _A = +25°C		T _A = -40°C to +85°C		Units	Conditions
			Min	Max	Min	Max		
V _{OL}	LOW Level	0.90		0.1		0.1	V	I _{OL} = 20 μA
	Output Voltage	1.10 ≤ V _{CC} ≤ 1.30		0.1		0.1		
		1.40 ≤ V _{CC} ≤ 1.60		0.1		0.1		
		1.65 ≤ V _{CC} ≤ 1.95		0.1		0.1		
		2.30 ≤ V _{CC} ≤ 2.70		0.1		0.1		
		3.00 ≤ V _{CC} ≤ 3.60		0.1		0.1		
		1.10 ≤ V _{CC} ≤ 1.30	0.30 x V _{CC}		0.30 x V _{CC}			I _{OL} = 0.5 mA
		1.40 ≤ V _{CC} ≤ 1.60	0.31		0.37			I _{OL} = 1.0 mA
		1.65 ≤ V _{CC} ≤ 1.95	0.31		0.35			I _{OL} = 1.5 mA
		2.30 ≤ V _{CC} ≤ 2.70	0.31		0.33			I _{OL} = 2.1 mA
3.00 ≤ V _{CC} ≤ 3.60	0.31		0.33		I _{OL} = 2.6 mA			
I _{IN}	Input Leakage Current	0.90 to 3.60		±0.1		±0.5	μA	0 ≤ V _I ≤ 3.6V
I _{OZ}	3-STATE Output Leakage	0.90 to 3.60		±0.5		±0.5	μA	V _I = V _{IH} or V _{IL} 0 ≤ V _O ≤ 3.6V
I _{OFF}	Power Off Leakage Current	0		0.5		0.5	μA	0 ≤ (V _I , V _O) ≤ 3.6V
I _{CC}	Quiescent Supply Current	0.90 to 3.60		0.9		0.9	μA	V _I = V _{CC} or GND

AC Electrical Characteristics

Symbol	Parameter	V _{CC} (V)	T _A = +25°C			T _A = -40°C to +85°C		Units	Conditions	Figure Number
			Min	Typ	Max	Min	Max			
t _{PHL} , t _{PLH}	Propagation Delay	0.90	26.0					ns	C _L = 10 pF R _L = 1 MΩ	Figures 1, 2
		1.10 ≤ V _{CC} ≤ 1.30	4.0	10.0	19.1	3.5	39.6			
		1.40 ≤ V _{CC} ≤ 1.60	2.0	6.0	11.2	1.5	14.5			
		1.65 ≤ V _{CC} ≤ 1.95	1.5	5.0	8.6	1.0	11.6			
		2.30 ≤ V _{CC} ≤ 2.70	1.0	4.0	6.3	0.8	8.2			
		3.00 ≤ V _{CC} ≤ 3.60	1.0	3.0	5.3	0.5	7.2			
t _{PZH} , t _{PZL}	Output Enable Time	0.90	29.0					ns	C _L = 10 pF R _U = 500Ω R _D = 5000Ω S ₁ = GND for t _{PZH} S ₁ = V _I for t _{PZL}	Figures 1, 2
		1.10 ≤ V _{CC} ≤ 1.30	4.0	8.0	17.5	3.5	40.4			
		1.40 ≤ V _{CC} ≤ 1.60	2.0	6.0	11.9	1.5	14.8			
		1.65 ≤ V _{CC} ≤ 1.95	1.5	5.0	9.7	1.0	12.3			
		2.30 ≤ V _{CC} ≤ 2.70	1.0	4.0	7.7	0.8	10.5			
		3.00 ≤ V _{CC} ≤ 3.60	1.0	3.0	6.9	0.5	8.6			
t _{PHZ} , t _{PLZ}	Output Disable Time	0.90	28.0					ns	C _L = 10 pF R _U = 500Ω R _D = 5000Ω S ₁ = GND for t _{PHZ} S ₁ = V _I for t _{PLZ}	Figures 1, 2
		1.10 ≤ V _{CC} ≤ 1.30	4.0	8.0	20.5	3.5	42.0			
		1.40 ≤ V _{CC} ≤ 1.60	2.0	6.0	15.3	1.5	18.0			
		1.65 ≤ V _{CC} ≤ 1.95	1.5	5.0	14.7	1.0	17.8			
		2.30 ≤ V _{CC} ≤ 2.70	1.0	4.0	13.7	0.8	15.0			
		3.00 ≤ V _{CC} ≤ 3.60	1.0	3.0	13.5	0.5	14.8			
t _{PHL} , t _{PLH}	Propagation Delay	0.90	28.0					ns	C _L = 15 pF R _L = 1 MΩ	Figures 1, 2
		1.10 ≤ V _{CC} ≤ 1.30	5.0	10.0	20.5	4.5	42.5			
		1.40 ≤ V _{CC} ≤ 1.60	3.0	7.0	11.8	2.5	15.4			
		1.65 ≤ V _{CC} ≤ 1.95	2.0	5.0	9.1	2.0	12.2			
		2.30 ≤ V _{CC} ≤ 2.70	1.5	4.0	6.6	1.0	8.6			
		3.00 ≤ V _{CC} ≤ 3.60	1.0	3.0	5.6	0.5	7.5			
t _{PZH} , t _{PZL}	Output Enable Time	0.90	31.0					ns	C _L = 15 pF R _U = 5000Ω R _D = 5000Ω S ₁ = GND for t _{PZH} S ₁ = V _I for t _{PZL}	Figures 1, 2
		1.10 ≤ V _{CC} ≤ 1.30	5.0	11.0	18.2	4.5	43.3			
		1.40 ≤ V _{CC} ≤ 1.60	3.0	7.0	12.5	2.5	15.5			
		1.65 ≤ V _{CC} ≤ 1.95	2.0	5.0	10.2	2.0	12.9			
		2.30 ≤ V _{CC} ≤ 2.70	1.5	4.0	8.0	1.0	9.9			
		3.00 ≤ V _{CC} ≤ 3.60	1.0	3.0	7.2	0.5	8.9			

AC Electrical Characteristics (Continued)										
Symbol	Parameter	V _{CC} (V)	T _A = +25°C			T _A = -40°C to +85°C		Units	Conditions	Figure Number
			Min	Typ	Max	Min	Max			
t _{PHZ} , t _{PLZ}	Output Disable Time	0.90 1.10 ≤ V _{CC} ≤ 1.30 1.40 ≤ V _{CC} ≤ 1.60 1.65 ≤ V _{CC} ≤ 1.95 2.30 ≤ V _{CC} ≤ 2.70 3.00 ≤ V _{CC} ≤ 3.60	5.0 3.0 2.0 1.5 1.0	30.0 11.0 7.0 5.0 3.0	21.6 15.9 15.2 14.1 13.9	4.5 2.5 2.0 1.0 0.5	44.9 18.8 18.2 15.4 15.1	ns	C _L = 15 pF R _U = 5000Ω R _D = 5000Ω S ₁ = GND for t _{PHZ} S ₁ = V _I for t _{PLZ}	Figures 1, 2
t _{PHL} , t _{PLH}	Propagation Delay	0.90 1.10 ≤ V _{CC} ≤ 1.30 1.40 ≤ V _{CC} ≤ 1.60 1.65 ≤ V _{CC} ≤ 1.95 2.30 ≤ V _{CC} ≤ 2.70 3.00 ≤ V _{CC} ≤ 3.60	5.5 4.0 2.0 1.0 0.8	34.0 12.0 8.0 6.0 5.0 4.0	23.4 13.8 10.6 7.6 6.4	5.0 3.0 2.0 1.0 0.5	51.1 17.7 14.0 9.9 8.9	ns	C _L = 30 pF R _L = 1 MΩ	Figures 1, 2
t _{PZH} , t _{PZL}	Output Enable Time	0.90 1.10 ≤ V _{CC} ≤ 1.30 1.40 ≤ V _{CC} ≤ 1.60 1.65 ≤ V _{CC} ≤ 1.95 2.30 ≤ V _{CC} ≤ 2.70 3.00 ≤ V _{CC} ≤ 3.60	6.0 4.0 2.0 1.0 0.8	37.0 13.0 8.0 6.0 5.0 4.0	24.4 14.5 11.7 9.1 8.1	5.0 3.0 2.0 1.0 0.5	51.9 17.9 14.7 11.1 10.1	ns	C _L = 30 pF R _U = 5000Ω R _D = 5000Ω S ₁ = GND for t _{PZH} S ₁ = V _I for t _{PZL}	Figures 1, 2
t _{PHZ} , t _{PLZ}	Output Disable Time	0.90 1.10 ≤ V _{CC} ≤ 1.30 1.40 ≤ V _{CC} ≤ 1.60 1.65 ≤ V _{CC} ≤ 1.95 2.30 ≤ V _{CC} ≤ 2.70 3.00 ≤ V _{CC} ≤ 3.60	6.0 4.0 2.0 1.0 0.8	36.0 13.0 8.0 6.0 5.0 4.0	24.8 17.1 16.5 15.2 14.8	5.0 3.0 2.0 1.0 0.5	53.5 21.1 20.5 16.7 16.3	ns	C _L = 30 pF R _U = 5000Ω R _D = 5000Ω S ₁ = GND for t _{PHZ} S ₁ = V _I for t _{PLZ}	Figures 1, 2
C _{IN}	Input Capacitance	0		2.0				pF		
C _{OUT}	Output Capacitance	0		4.0				pF		
C _{PD}	Power Dissipation Capacitance	0.9 to 3.60		10.0				pF	V _I = V _O or V _{CC} , f = 10 MHz	

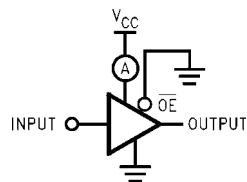
AC Loading and Waveforms



C_L includes load and stray capacitance

Input PRR = 1.0 MHz; $t_w = 500$ ns

FIGURE 1. AC Test Circuit



Input = AC Waveform; $t_r = t_f = 1.8$ ns;

PRR = 10 MHz; Duty Cycle = 50%

FIGURE 2. I_{CCD} Test Circuit

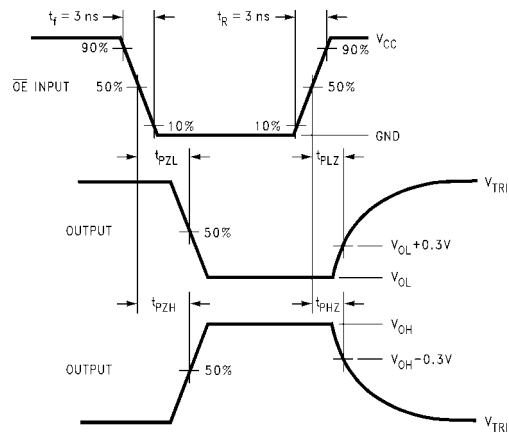
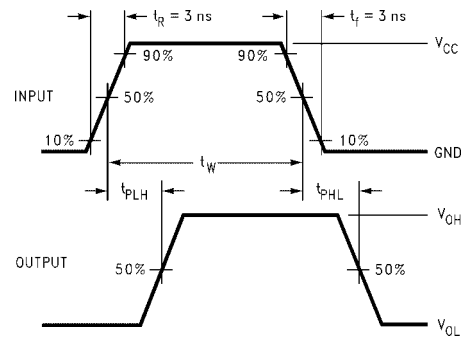


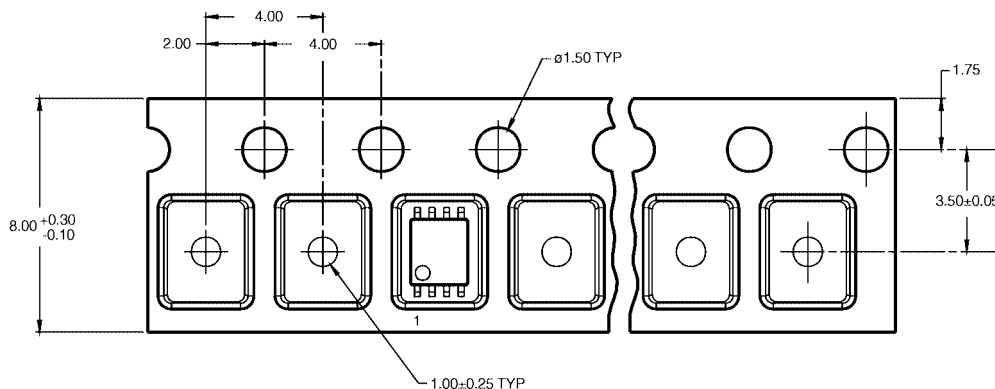
FIGURE 3. AC Waveforms

Symbol	V_{CC}					
	$3.3V \pm 0.3V$	$2.5V \pm 0.2V$	$1.8V \pm 0.15V$	$1.5V \pm 0.10V$	$1.2V \pm 0.10V$	$0.9V$
V_{mi}	1.5V	$V_{CC}/2$	$V_{CC}/2$	$V_{CC}/2$	$V_{CC}/2$	$V_{CC}/2$
V_{mo}	0.3V	0.15V	0.15V	0.10V	0.10V	0.10V

TAPE FORMAT for US8

Package Designator	Tape Section	Number Cavities	Cavity Status	Cover Tape Status
K8X	Leader (Start End)	125 (typ)	Empty	Sealed
	Carrier	3000	Filled	Sealed
	Trailer (Hub End)	75 (typ)	Empty	Sealed

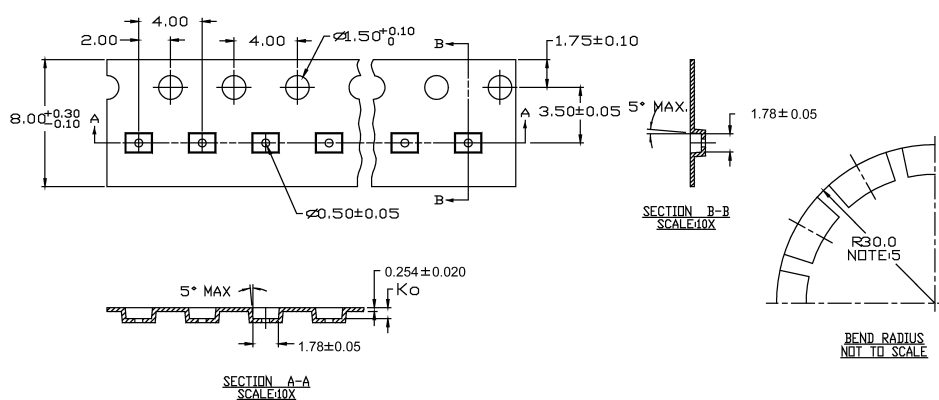
TAPE DIMENSIONS inches (millimeters)



TAPE FORMAT for MicroPak

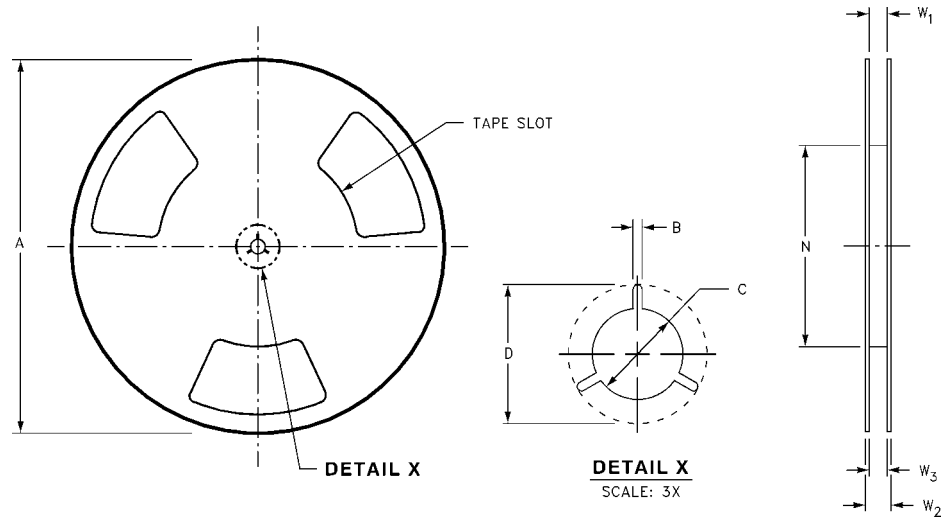
Package Designator	Tape Section	Number Cavities	Cavity Status	Cover Tape Status
L8X	Leader (Start End)	125 (typ)	Empty	Sealed
	Carrier	3000	Filled	Sealed
	Trailer (Hub End)	75 (typ)	Empty	Sealed

TAPE DIMENSIONS inches (millimeters)



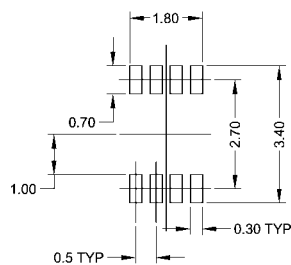
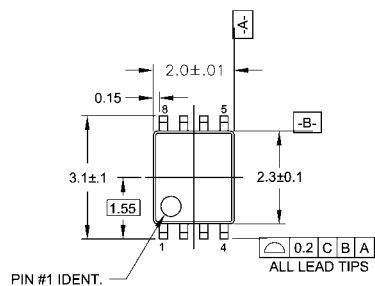
Tape and Reel Specification (Continued)

REEL DIMENSIONS inches (millimeters)

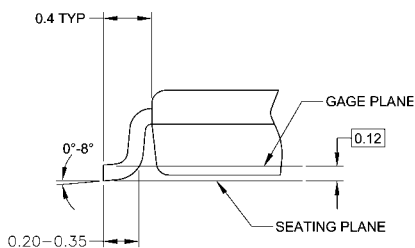
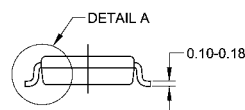
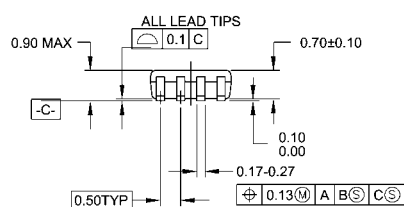


Tape Size	A	B	C	D	N	W1	W2	W3
8 mm	7.0 (177.8)	0.059 (1.50)	0.512 (13.00)	0.795 (20.20)	2.165 (55.00)	$0.331 + 0.059/-0.000$ (8.40 + 1.50/-0.00)	0.567 (14.40)	$W1 + 0.078/-0.039$ (W1 + 2.00/-1.00)

Physical Dimensions inches (millimeters) unless otherwise noted



LAND PATTERN RECOMMENDATION



DETAIL A

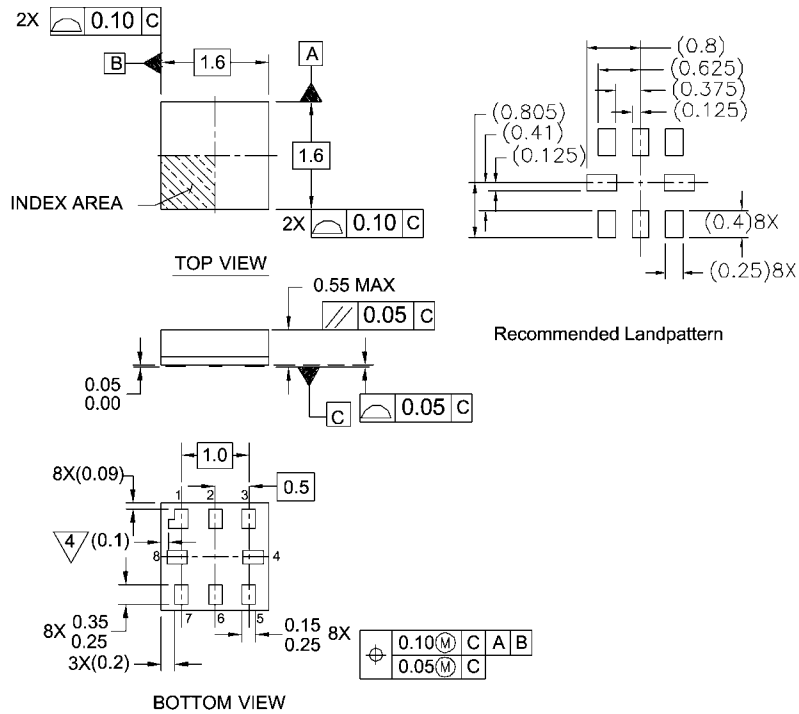
NOTES:

- CONFORMS TO JEDEC REGISTRATION MO-187
- DIMENSIONS ARE IN MILLIMETERS.
- DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- DIMENSIONS AND TOLERANCES PER ANSI Y14.5M, 1982.

MAB08AREVC

8-Lead US8, JEDEC MO-187, Variation CA 3.1mm Wide
Package Number MAB08A

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



Notes:

1. PACKAGE CONFORMS TO JEDEC MO-255 VARIATION UAAD
2. DIMENSIONS ARE IN MILLIMETERS
3. DRAWING CONFORMS TO ASME Y.14M-1994
4. PIN 1 FLAG, END OF PACKAGE OFFSET.

MAC08AREVC

**Pb-Free 8-Lead MicroPak, 1.6 mm Wide
Package Number MAC08A**

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